

## DDS-Based Clock Jitter Performance vs. DAC Reconstruction Filter Performance

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A reconstruction filter is an important element for creating a clean, low jitter clock signal from a direct digital synthesizer (DDS). A reconstruction filter is used at the output of the DAC to attenuate image frequencies. However, a physical filter cannot be implemented with ideal stop band rejection extending out to infinite frequency. This is due to component parasitic effects as well as the physical limitations of printed circuit board layout. Failing to use a reconstruction filter with sufficient stop-band rejection can degrade the performance of the DDS.

### A FILTER LAYOUT EXPERIMENT

This application note describes the results obtained from a filter layout experiment and discusses how layout and component selection impact stop-band rejection. This experiment focuses on three LC low-pass filter layouts described in this application note as Filter A, Filter B, and Filter C. All three filters are nearly identical in terms of component values and desired response characteristics. The purpose of the experiment is to restrict the experimental variables to the physical layout and the physical construction of the components.

A companion application note, [AN-823](#), also available from Analog Devices, Inc., should be used in conjunction with this application note.

When using a DDS for clock generation, insufficient attenuation of DAC image frequencies can significantly affect system periodic jitter performance. Image frequencies theoretically extend to infinity frequency with magnitudes that follow a  $\sin(x)/x$  response curve. Figure 1 depicts the DAC output spectrum.

The following formula calculates the theoretical magnitude (dBc) of any desired image frequency relative to  $f_{OUT}$ , where  $f$  is the frequency of the image and  $f_c$  is the DAC sample rate:

$$dBc = 20 \log \left\{ \left( \frac{f_{OUT}}{f} \right) \left( \frac{\sin \left( \frac{\pi f}{f_c} \right)}{\sin \left( \frac{\pi f_{OUT}}{f_c} \right)} \right) \right\}$$

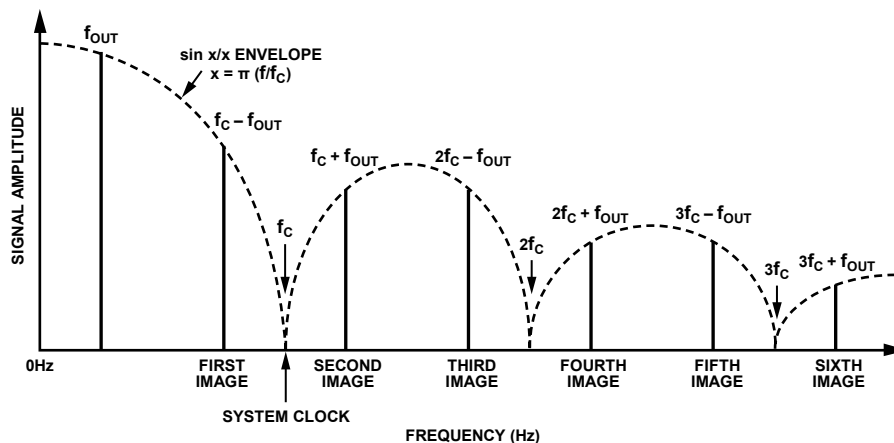


Figure 1. The DAC Output Spectrum

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## THE IMPORTANCE OF A RECONSTRUCTION FILTER

Figure 2 displays the measured power of the image frequencies in the absence of a reconstruction filter. The displayed attenuation of the image frequencies is due solely to the  $\sin(x)/x$  response of the DAC output. Sometimes these images are used as the desired signal, in which case a band-pass filter is required instead of a low-pass filter. In the spectral plot in Figure 2, the DDS sampling clock ( $f_c$ ) is 200 MHz and  $f_{OUT}$  is set to 10 MHz.

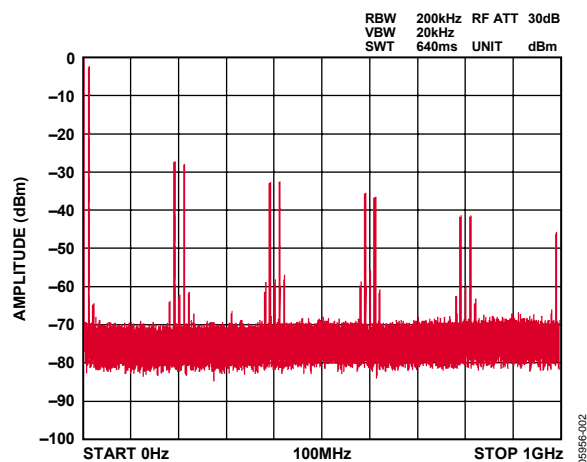


Figure 2. Example of Image Frequencies without a Reconstruction Filter

This plot (Figure 2) demonstrates the importance of using a reconstruction filter with adequate stop-band rejection. Note that there is significant energy contained in the image frequencies that must be eliminated, and the task of elimination falls squarely on the stop band performance of the filter. Unfortunately, the stop-band rejection of a practical filter degrades as frequencies extend well beyond the pass band. This is due to nonideal components and the physical layout of the components on a printed circuit board (PCB). For example, real capacitors and inductors are not strictly capacitive or inductive.

Each can be modeled as having resistive (R), inductive (L) and capacitive (C) elements, as shown in Figure 3. From these models, it is evident that there is a self-resonant component made up of the L and C combination and an insertion loss component due to R.

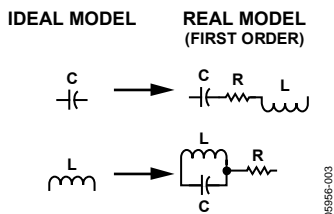


Figure 3. Ideal Model vs. Real Model

Filter layout can significantly affect stop-band rejection due to parasitic capacitance between trace pads of the components, which can unintentionally couple signals from input to output. Optimal stop band rejection requires attention to both component selection and layout details. To evaluate the stop band performance of a filter, it should be measured at frequencies well beyond its designed corner frequency to ensure that image

frequencies can be adequately rejected. The recommendation is to observe stop-band rejection out to several gigahertz, or at least out to  $5 f_c$ .

Off-the-shelf filters such as SAW, crystal, ceramic, or pre-packaged LC filters are valid candidates for reconstruction filters. However, before choosing a filter type, take care to determine the stop-band rejection and insertion loss stated in the filter manufacturer's data sheet. The stop-band rejection specification is always given for a finite bandwidth. This bandwidth may be too narrow to determine its adequacy with regards to extended stop-band rejection. In such cases, validate the filter stop-band performance before a final selection is made.

## DESIGNING A DISCRETE LC LOW-PASS FILTER

A discrete LC low-pass filter is relatively inexpensive to implement and offers significant flexibility. From a component selection perspective, achieving optimal pass-band and stop-band performance begins with choosing components with a high self-resonant frequency and a high Q property. Components with a high Q rating are desirable for their lower series R value. In a low-pass filter, this can decrease the insertion loss for the series inductors and decrease the impedance for the shunt capacitors. Consequently, the task of choosing components with both high Q and high self-resonant frequency can be challenging. Generally, the physics involved in the construction of capacitors and inductors tends to make high Q and high self-resonant frequency mutually exclusive parameters. Components must be carefully selected to yield optimal performance.

### Choosing Components

The self-resonant frequency of each component is dictated by the component value and its physical construction. Choosing a smaller size package is usually a better choice. A smaller package generally exhibits a higher self-resonant frequency and reduces the parasitic effects associated with PCB layout. In the case of shunt capacitors, the self-resonance can be pushed out to higher frequencies by using two capacitors connected in parallel with only one-half the value of the original component. The impact of this technique is described in the Filter Experiment Results section.

Choosing components with less insertion loss provides more signal amplitude at the filter output. A reduction in amplitude has a direct impact on the slew rate of the output signal. Increased slew rate applied to the input of a receiver or squarer decreases wide band noise. Refer to AN-823 for details on the importance of signal amplitude in the context of timing jitter.

## IMPLEMENTATION OF A DISCRETE LC LOW-PASS ELLIPTIC FILTER

A filter of the elliptical, or Cauer, response variety is typically recommended for an LC low-pass reconstruction filter. When compared to the other response types, an elliptic filter offers the fastest transition from pass band to stop band for a given level of complexity (that is, filter order).

This characteristic makes the elliptic filter an attractive candidate as a reconstruction filter. Figure 4 displays a set of representative response curves of these four basic filter types: Cauer, Chebyshev, Butterworth, and Bessel.

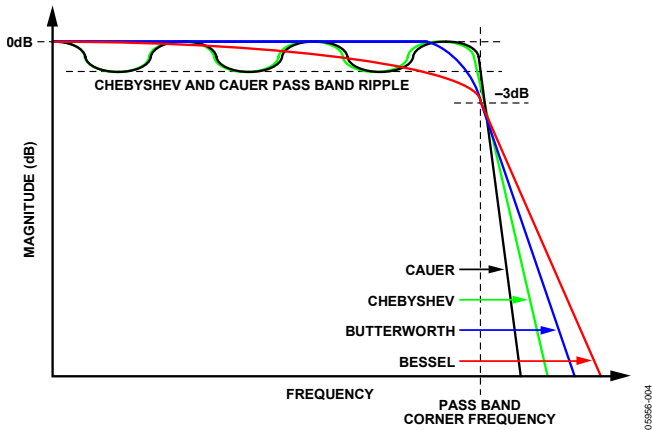


Figure 4. Response Curves for Four Basic Filter Types

The tradeoff for the steep roll-off offered by the elliptic response is the appearance of response ripples in the pass band and the stop band. Note that the magnitude of the pass-band ripple shown in Figure 4 was arbitrarily drawn for demonstration purposes only. Although some pass-band ripple is necessary in an elliptic filter design, it is one of the parameters that the filter designer can control. Therefore, its magnitude is dependent on the particular filter design.

Pass-band ripple can impact certain DDS applications. In single tone applications, such as carrier signal generation, pass-band ripple is not a critical parameter. However, in those applications where the DDS generates a modulated carrier, pass-band ripple must be considered as a crucial factor in the filter design.

LC filters are available in two general forms dictated by whether the driving circuit is a current source or voltage source. If driven by a current source, the first element is shunt connected, whereas the first element is series connected for a voltage source.

Figure 5 shows a shunt-connected, seventh-order, elliptical, low-pass LC filter.

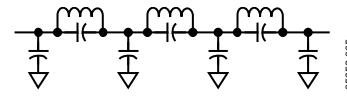


Figure 5. Shunt-Connected LC Filter

## FILTER EXPERIMENT RESULTS

Figure 7 displays the results obtained from the experimental filter board containing Filter A, Filter B, and Filter C. The top trace in each plot is the measured frequency response of the filter; the bottom trace is the measured spectrum from a DDS evaluation board after passing through the experimental filter.

The measurement configuration is shown in Figure 6.

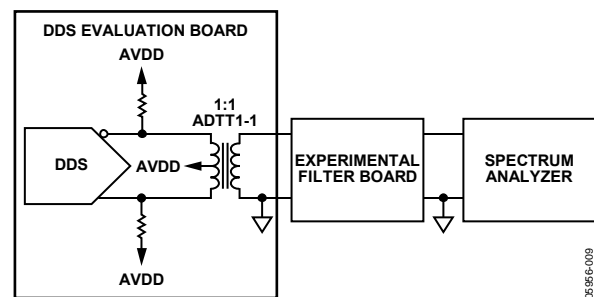


Figure 6. Measurement Configuration

Note that the DSS evaluation board contains an output coupling transformer that has a bandwidth of ~300 MHz. Therefore, there is additional attenuation in the measured spectrum at frequencies above 300 MHz due to the response of the transformer.

The three LC low-pass elliptic filter implementations demonstrate varying image rejection due to PCB layout. All three implementations are seventh-order elliptical 160 MHz low-pass filters using discrete LC components.

The DDS filtered output frequency for all plots is set to 110.123 MHz with a DAC sample rate of 500 MSPS (REFCLK). Note that a transformer (ADTT1-1 available from Mini-Circuits®) differentially couples the DDS outputs. The transformer output provides a single-ended connection to the filter input.

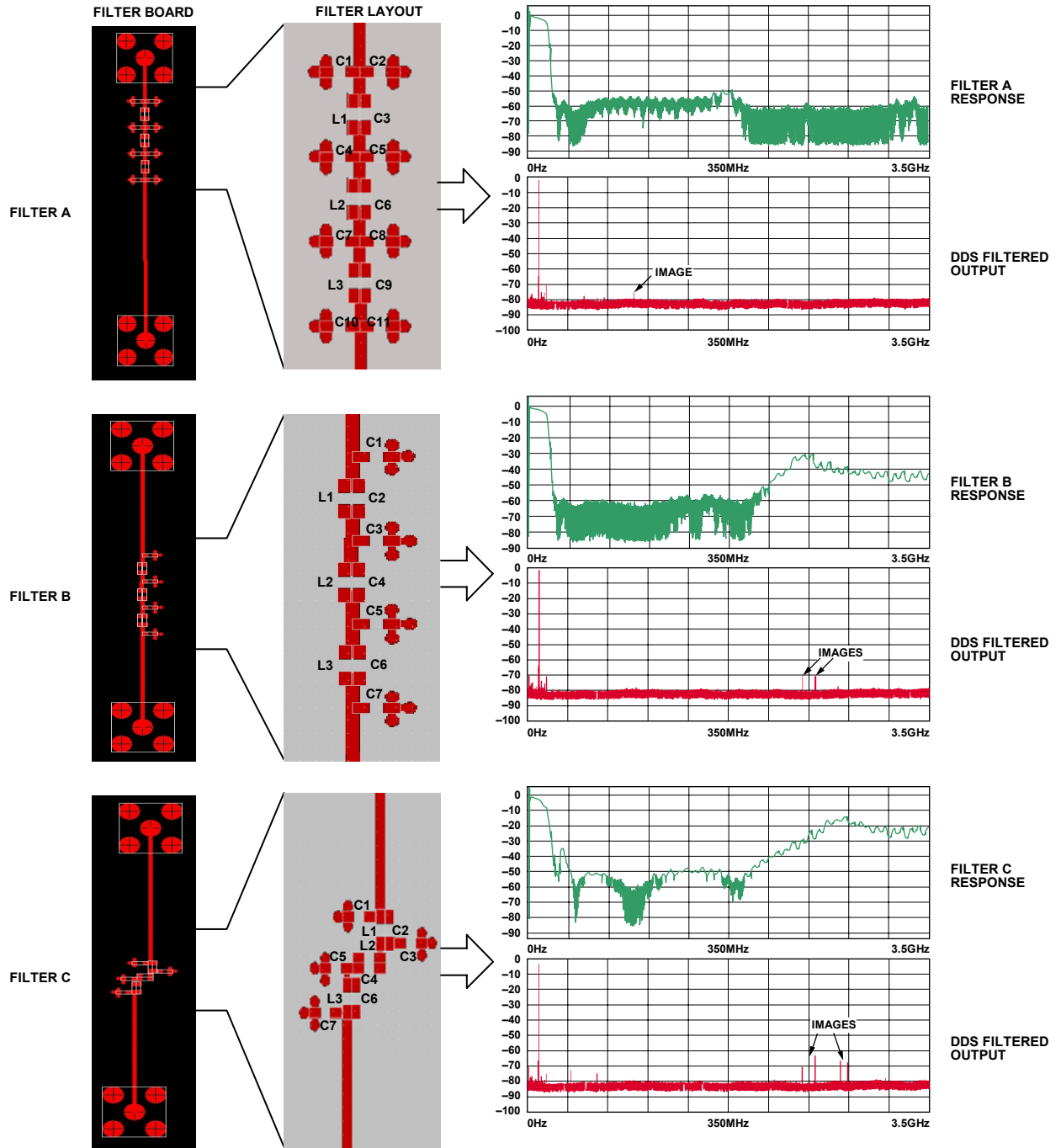


Figure 7. Experiment Results for Filter A, Filter B, and Filter C

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The measured frequency response of the filters shown in Figure 7 is from 0 Hz to 3.5 GHz (the upper frequency limit of the measurement instrument). For a 1 GHz DDS, it is recommended that measurements extend beyond 3.5 GHz to better characterize the filter stop-band response.

In applications requiring very low jitter, adequate suppression of DAC image frequencies is critical. In fact, there is a direct relationship between the magnitude of a nonharmonic spectral spur and the resulting periodic jitter, given by:

$$JitterUI_{peak-to-peak} = \frac{1}{\pi} \arctan \left( 10^{\frac{dBc}{20}} \right)$$

where *dBc* is the spur magnitude relative to the fundamental magnitude.

A plot of this formula is shown in Figure 8. The jitter is expressed as peak-to-peak unit intervals (UI). One UI is one period of the associated clock signal. Expressing the jitter in UI allows the plot to apply to any arbitrary clock signal. For example, if a clock signal exhibits a -35 dBc nonharmonic spur, then one can expect about 0.006 UI of peak-to-peak jitter due solely to the spur.

Assuming a clock frequency of 100 MHz, then 1 UI is 10 ns, therefore 0.006 UI equates to 60 ps ( $0.006 \times 10 \text{ ns}$ ) for a 100 MHz clock. When using this plot, keep in mind that the jitter values are for a single spurious component. When multiple spurs are present, their individual contributions must be summed in the argument for the arctan function as shown in the previous equation.

For example, the peak-to-peak jitter associated with *N* spurs takes the form:

$$JitterUI_{peak-to-peak} = \frac{1}{\pi} \arctan \left( \sum_{n=1}^N 10^{\frac{dBc_n}{20}} \right)$$

Furthermore, the plot does not address random jitter, the effects of which must be considered separately.

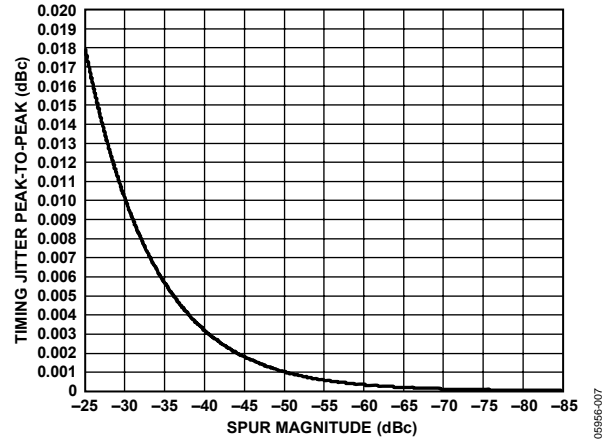


Figure 8. Timing Jitter vs. Spurious Interference

**FILTER SCHEMATICS**

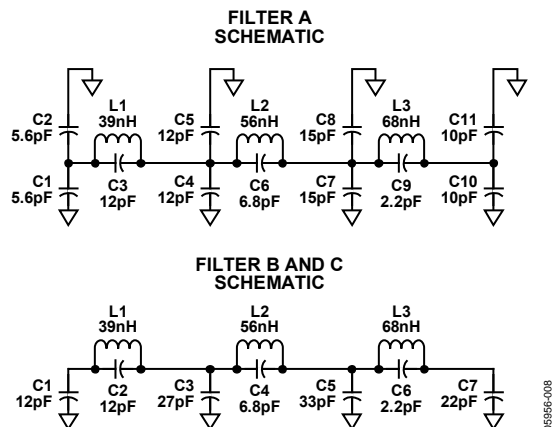


Figure 9. Schematic for Filter A Compared to Schematic for Filter B and Filter C

**BILLS OF MATERIALS FOR FILTERS**

The Bill of Materials for Filter A is provided in Table 1 while the Bill of Materials for Filter B and Filter C are provided in Table 2. Note that the following points for these Bills of Materials:

- The quantity for all materials is 1.
- The size of all materials is 0402.
- All materials are Murata Manufacturing Company, Ltd. parts.

**Table 1. Filter A Bill of Materials**

Reference Designator	Value	Supplier Part Number
C1	5.6 pF	GRM1555C1H5R6DZ01
C2	5.6 pF	GRM1555C1H5R6DZ01
C3	12 pF	GRM1555C1H120JZ01
C4	12 pF	GRM1555C1H120JZ01
C5	12 pF	GRM1555C1H120JZ01
C6	6.8 pF	GRM1555C1H6R8DZ01
C7	15 pF	GRM1555C1H150JZ01
C8	15 pF	GRM1555C1H150JZ01
C9	2.2 pF	GRM1555C1H2R2CZ01
C10	10 pF	GRM1555C1H100JZ01
C11	10 pF	GRM1555C1H100JZ01
L1	39 nH	LQG15HS39NJ02D
L2	56 nH	LQG15HS56NJ02D
L3	68 nH	LQG15HS68NJ02D

**Table 2. Filter B and Filter C Bill of Materials**

Reference Designator	Value	Supplier Part Number
C1	12 pF	GRM1555C1H120JZ01
C2	12 pF	GRM1555C1H120JZ01
C3	27 pF	GRM1555C1H270JZ01
C4	6.8 pF	GRM1555C1H6R8DZ01
C5	33 pF	GRM1555C1H330JZ01
C6	2.2 pF	GRM1555C1H2R2CZ01
C7	22 pF	GRM1555C1H220JZ01
L1	39 nH	LQG15HS39NJ02D
L2	56 nH	LQG15HS56NJ02D
L3	68 nH	LQG15HS68NJ02D

## PCB FILTER LAYOUT CONSIDERATIONS

The list below offers useful layout tips for obtaining optimal performance from the reconstruction filter.

- Use a solid (uninterrupted) ground plane below the components to lower the loop inductance of the circuit, thus lowering the impedance for return currents.
- Split shunt capacitors as shown with Filter A (see Figure 7) to increase the self-resonant frequency of the capacitors and lower the inductive connection to ground. In addition, use a top ground plane alongside for the shunt components in combination with the bottom ground plane. This can further lower the inductive connection to ground. Use multiple vias to tie both ground planes together.
- Avoid placing the filter components in close proximity with one another. Filter C (see Figure 7) is a good example of a layout where components are crowded. When components are crowded, trace parasitics and mutual coupling can affect the frequency response of the filter.
- Use components with both as high a self-resonant frequency and as high a Q factor as possible.
- Maintain the impedance of the traces to match the characteristic impedance of the filter. This is not as critical for component interconnections, but it is important for the traces that interface to circuits external to the filter, such as the input and output connections.

## FINAL POINTS

A DDS is a sampled data system that produces a spectrum with multiple copies of the fundamental arrayed around multiples of the sampling frequency.

The magnitude of these image frequencies can be the dominant source of periodic jitter. Any spur present at the output of the filter and within the input bandwidth of the receiver degrades performance in proportion to the spur magnitude. Therefore, before settling on a DAC reconstruction filter, measure the filter performance to ensure that it meets the requirements of the application.

Keep in mind that filter design software programs that do not support the inclusion of component and layout parameters only simulate the ideal filter frequency response. The actual frequency response varies depending on the actual high frequency characteristics of the components and the printed circuit board.